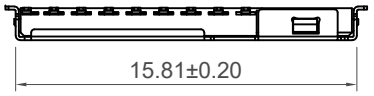
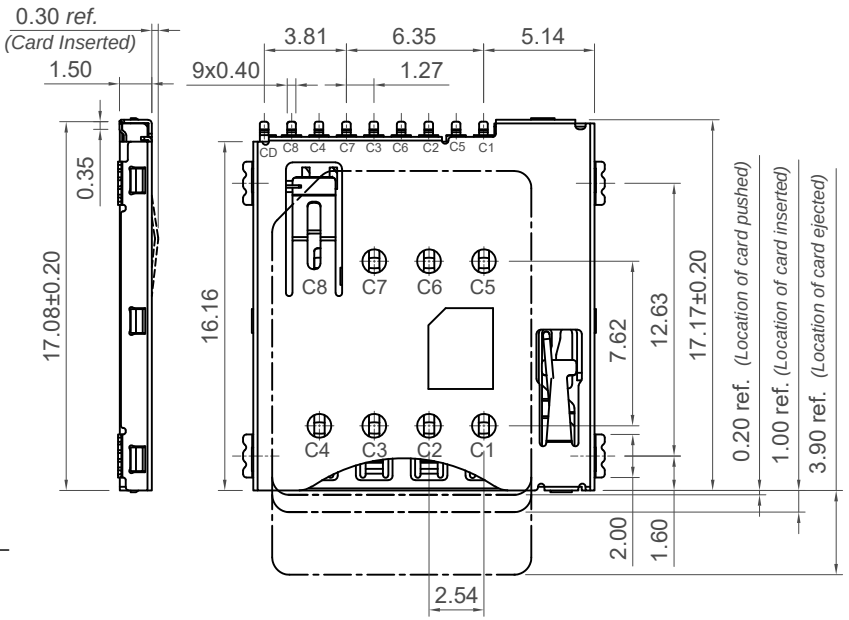
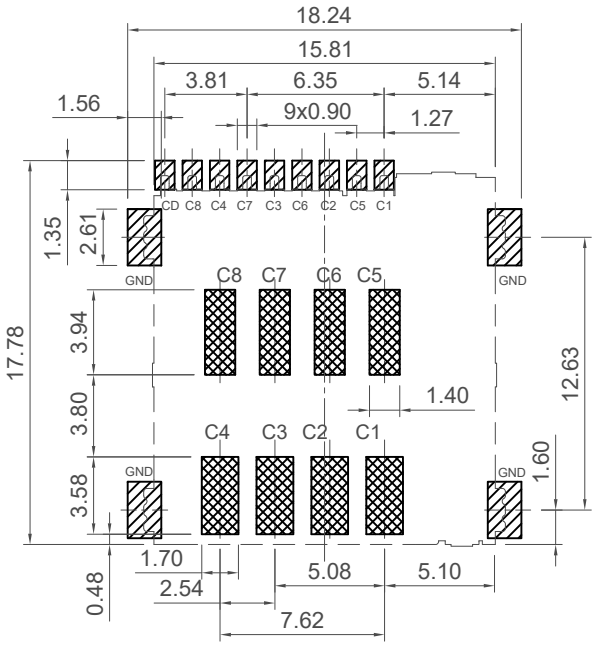
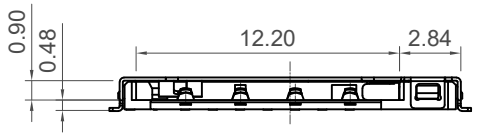
All elements marked as C4 and C8 apply only to 8 contact version.

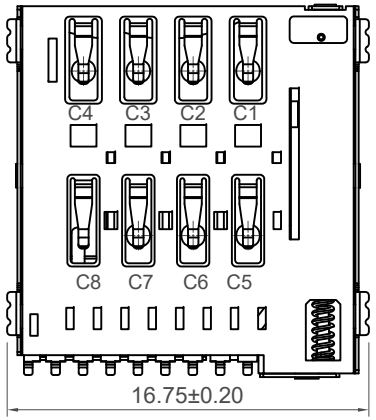




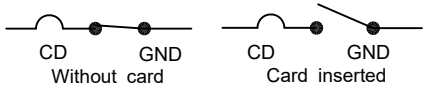


Recommended PCB Layout
General Tolerance ±0.05
Locating peg holes only applicable to locating peg version
Solder Area Keep Out Area Component Outline

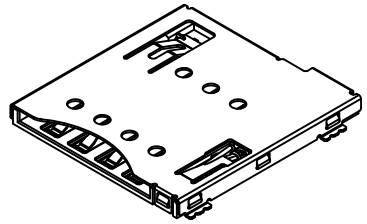




Electric Function	Detect Switch
Without Card	Closed
Card Inserted	Open



Switch Operation Diagram



Specification:

Material:
- Plastic Housing&Slider:
  Thermoplastic, UL94V-0, Black
- Contact Terminal & Card Detection Switch :
  Phosphor Bronze
- Shell,Cam Pin: Stainless Steel
- Coil Spring: SWP (steel)

Plating:
- Contact Terminal:
  - Contact Area: 3µ" Gold
  - Solder area: Gold Flash
  - Underplating: Ni overall 50µ" min.
- Shell: Ni overall, 30µ" min.
  Solder area: Gold Flash

Electrical:
- Voltage Rating: 50V max.
- Current Rating: 1A max.
- Dielectric Withstanding: 500V AC
- Insulation Resistance: 1000 MΩ min.
- Contact Resistance: 100 mΩ max. (signal)
  300 mΩ max. (switch)

Mechanical:
- Duration: 1500 cycles
- Operating Temperature: -40°C to +85°C

Ordering Grid

SIM7100 — X — 1 — 15 — 00 — A (Request Samples and Quotation)

- No. of Contacts: 6 or 8
- Switch: 1 = With *(normally closed)*
- Profile Height: 15 = 1.50mm
- Packing Options: A = Tape & Reel *(1,000 per reel)*
- Locating Peg: **00 = Without**

Part Number	Product Description
SIM7100	Micro SIM Card Connector - Push-Push Type 6 or 8 Pin, SMT, 1.50mm Profile
Drawing Date: 12th September 2014	

By	CC
Detail	SIM7100 C PCN
Revision	C2
Date	15/06/21

Tolerances (Except as Noted): Length X. ± 0.35, X.X ± 0.25, X.XX ± 0.15, X.XXX ± 0.10; Angle X.° ± 5°, X.X° ± 4°, X.XX° ± 3°, X.XXX° ± 2°

Units: Metric (mm) — 3rd Angle Projection

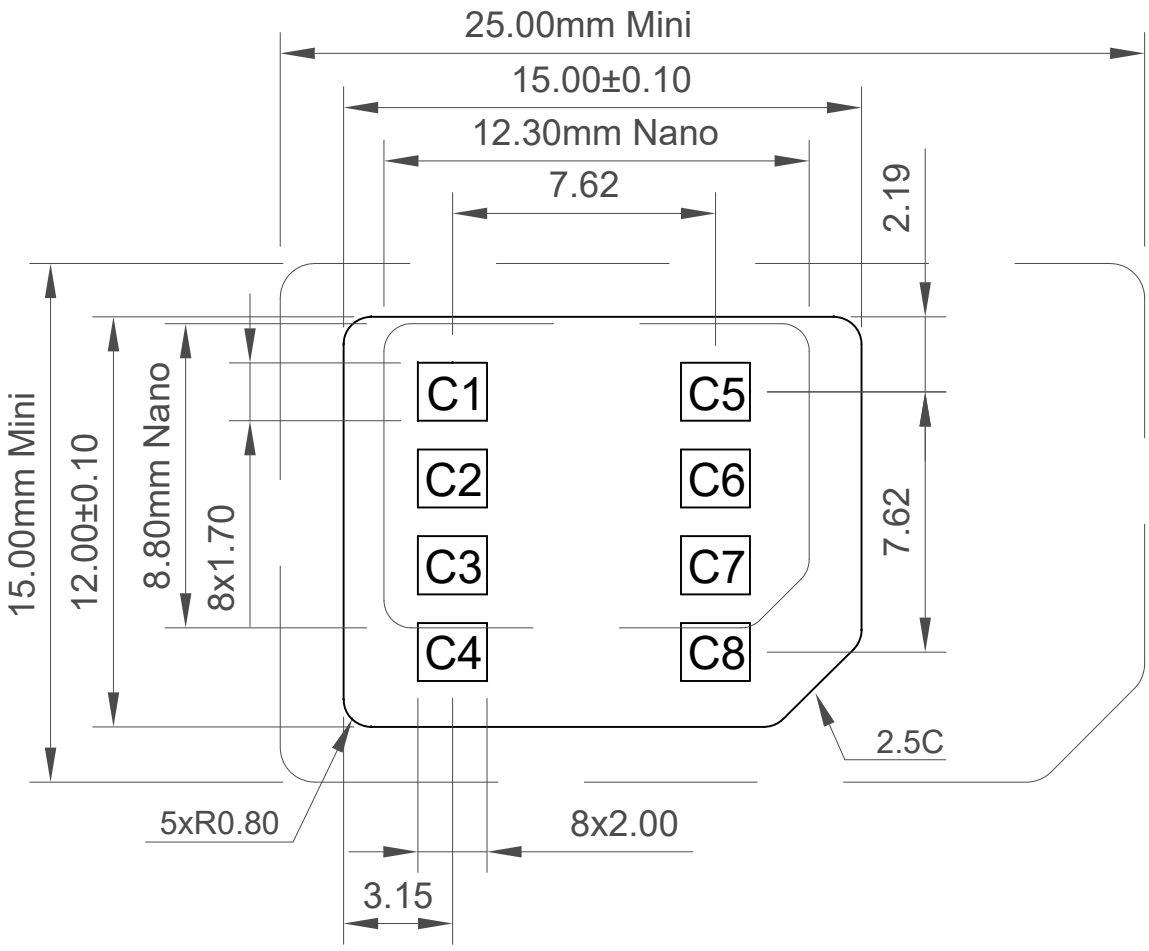
RoHS COMPLIANT 2011/65/EU Deca-BDE

GCT www.gct.co

Not to Scale	Drawn By AJO	Sheet No. 1/3

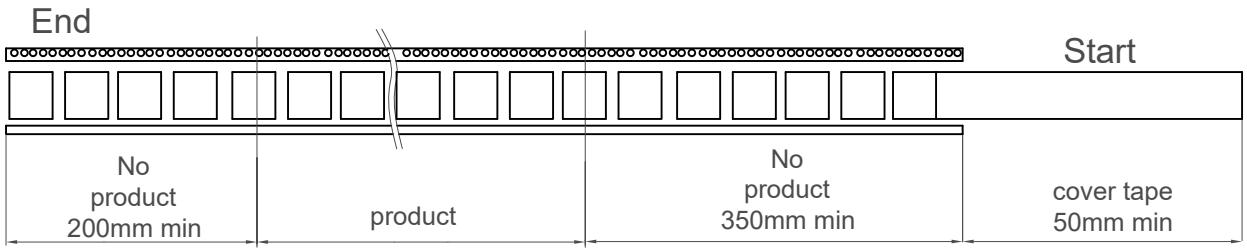
Micro SIM Reference

thickness = 0.76±0.08

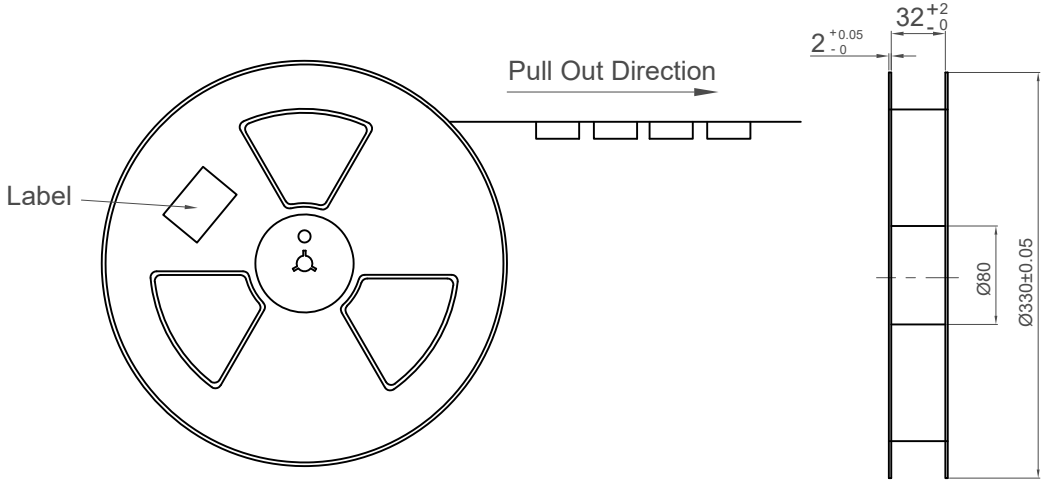


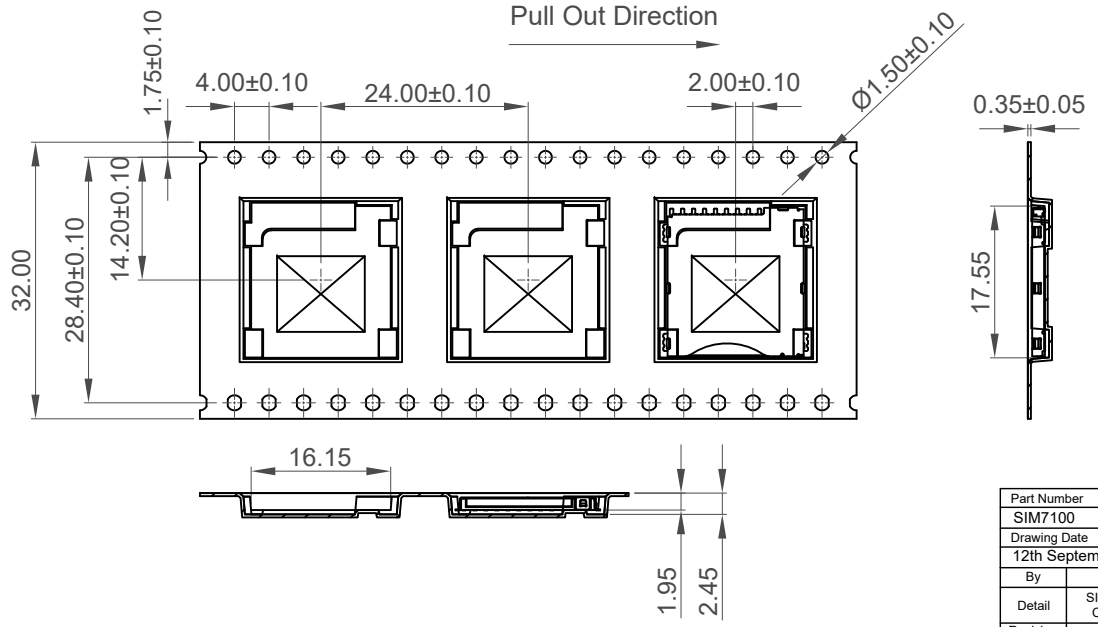
C1	VCC
C2	RST
C3	CLK
C4	RFU
C5	GND
C6	Vpp
C7	I/O
C8	RFU

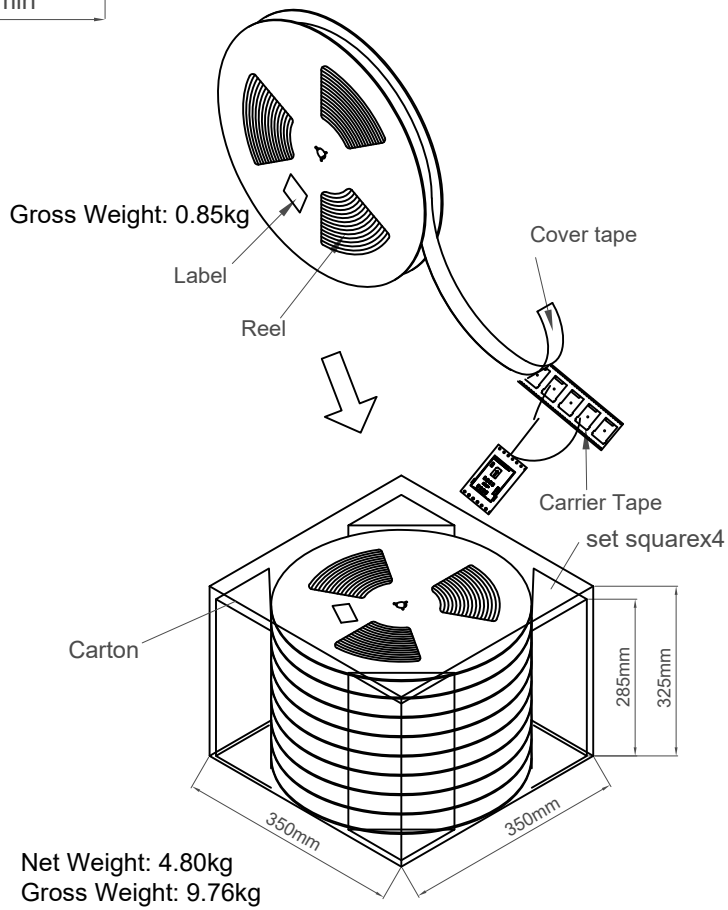
Part Number		Product Description						
SIM7100		Micro SIM Card Connector - Push-Push Type 6 or 8 Pin, SMT, 1.50mm Profile						
Drawing Date								
12th September 2014								
By	CC	Tolerances (Except as Noted)		Units: Metric (mm)	RoHS COMPLIANT 2011/65/EU Deca-BDE		GCT www.gct.co	
Detail	SIM7100 C PCN	Length	Angle					
		X. ± 0.35 X.X ± 0.25 X.XX ± 0.15 X.XXX ± 0.10	X.° ± 5° X.X° ± 4° X.XX° ± 3° X.XXX° ± 2°	3rd Angle Projection				
Revision	C2						Not to Scale	Drawn By AJO
Date	15/06/21							Sheet No. 2/3



Products P/N	PCS/Reel	Reels/Carton	PCS/Carton
SIM7100	1000	8	8000







Net Weight: 4.80kg
Gross Weight: 9.76kg

Part Number	Product Description
SIM7100	Micro SIM Card Connector - Push-Push Type 6 or 8 Pin, SMT, 1.50mm Profile
Drawing Date	
12th September 2014	

By	CC
Detail	SIM7100 C PCN
Revision	C2
Date	15/06/21

Tolerances (Except as Noted): Length, Angle

Units: Metric (mm)

3rd Angle Projection

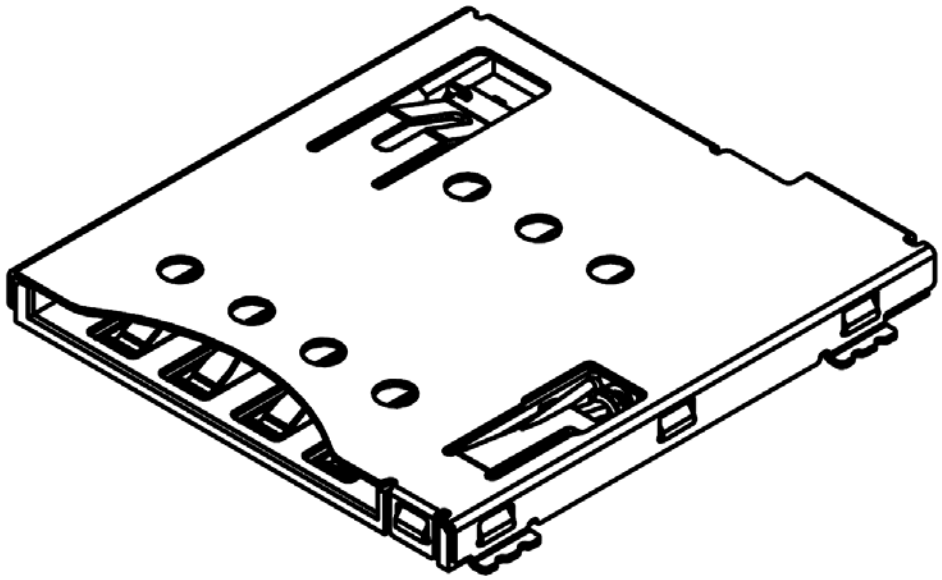
RoHS COMPLIANT 2011/65/EU Deca-BDE

GCT www.gct.co

Not to Scale	Drawn By AJO	Sheet No. 3/3

PRODUCT SPECIFICATION

Part Number	SIM7100		**Rev**	C		**Date**	17/12/19
Product Description	Micro SIM Card Connector, Push-Push, 6 or 8 Pin, SMT, 1.5mm Profile, With Card Detection Switch					**Page**	1
Doc Number	SIM7100	**Prepared**	**CC**	**Checked**	**VJ**	**Approved**	**PH**



PRODUCT SPECIFICATION

Part Number	SIM7100		**Rev**	C		**Date**	17/12/19
Product Description	Micro SIM Card Connector, Push-Push, 6 or 8 Pin, SMT, 1.5mm Profile, With Card Detection Switch					**Page**	2
Doc Number	SIM7100	**Prepared**	**CC**	**Checked**	**VJ**	**Approved**	**PH**

1.0 SCOPE.

This specification covers performance, tests and quality requirements for the Micro SIM Card Connector SIM 7100 (Push-Push Type, 6 or 8 Pin, SMT, 1.5mm Profile).

2.0 PRODUCT NAME AND PART NUMBER.

Micro SIM Card Connector, 6 or 8 Pin, Push-Push Type: SIM7100.

3.0 PRODUCT SHAPE, DIMENSIONS AND MATERIAL.

Please refer to drawings.

4.0 RATINGS.

Current rating ……. 1.0 Amp Max.

Voltage rating …… 50 Volts DC Max.

Operating Temperature Range …… -40°C to +85°C

Storage Temperature …… -40°C to +85°C

5.0 TEST AND MEASUREMENT CONDITIONS.

Product is designed to meet electrical, mechanical and environmental performance requirements specified in Paragraph 6.0. All tests are performed at ambient environmental conditions unless otherwise specified.

6.0 PERFORMANCE.

Item	Test Condition	Requirement
Examination of Product	Visual, dimensional and functional inspection as per quality plan.	Product shall meet requirements of product drawing and specification.

6.1 Electrical Performance.

Item	Test Condition	Requirement
Contact Resistance	Mate connector, measure and record contact resistance using test a current of 10mA max and 20mV open circuit voltage, in accordance with IEC 60512-2-1.	Signal: 100 mΩ Max. Switch: 300 mΩ Max
Insulation Resistance	Apply 500Volts DC between adjacent contacts of unmated connector for one minute, in accordance with IEC 60512-3-1.	1000 MΩ minimum
Dielectric Strength	Unmated connector with 500 VAC for 1 minute between adjacent contacts, in accordance with IEC 60512-3-1.	No creeping discharge or flash over.

6.2 Mechanical Performance.

Item	Test Condition	Requirement
Durability	The SIM card should be mated and unmated for 1500 cycles at a rate of 500 cycles/ hour.	No evidence of physical damage. Contact Resistance Signal: 100 mΩ Max. Switch: 300 mΩ Max at end of test
Vibration(Random)	Frequency: 10 -100 Hz ,0.0132g2/Hz ; 100 - 500Hz, -3dB/Oct. Applied for 1 hour in each 3 mutually perpendicular axes In accordance with IEC60068-2-64Fh.	No evidence of physical damage Contact Resistance Signal: 100 mΩ Max. Switch: 300 mΩ Max at end of test Current discontinuity ≦1 μs
Mechanical Shock	Pulse shape=half sine Peak acceleration =50G Duration of pulse=11ms Apply 3 shocks in each direction along the 3 mutually perpendicular axes (18 shocks). In accordance with IEC60068-2-27Ea.	No evidence of physical damage Contact Resistance Signal: 100 mΩ Max. Switch: 300 mΩ Max at end of test Current discontinuity≦ 1 μs .

6.3 Environmental Performance and Others.

Item	Test Condition	Requirement
Thermal Shock	The card shall be mated and exposed to the following condition for 25 cycle at T_a = -40ºC for 0.5 hours; change of temp=25ºC maximum 5min; then T_b=+85ºC for 0.5 hours; cool to ambient. In accordance with IEC60068-2-14.	No evidence of physical damage, Contact Resistance Signal: 100 mΩ Max. Switch: 300 mΩ Max
Humidity Test	The card shall be mated and exposed to temperature of 40±2°C with 90-95% RH for 500 hours then place in ambient temperature for 1 to 2 hrs. In accordance with IEC60068-2-3.	No evidence of physical damage, Contact Resistance Signal: 100 mΩ Max. Switch: 300 mΩ Max Insulation resistance ≥1000 MΩ Dielectric: No creeping discharge or flash over.
Salt mist	5±1% salt concentration 24 hours 35±2ºC. In accordance with IEC60068-2-11.	No rust on contact area Contact Resistance Signal: 100 mΩ Max. Switch: 300 mΩ Max
Temperature Life (High)	85±2°C for 96 hours. Recovery time 1-2 hours under ambient conditions. In accordance with IEC60068-2-2Bb.	No evidence of physical damage, Contact Resistance Signal: 100 mΩ Max. Switch: 300 mΩ Max
Temperature Life (Low)	-40±3°C for 96 hours. Recovery time 1-2 hours under ambient conditions. In accordance with IEC60068-2-1Ab	No evidence of physical damage, Contact Resistance Signal: 100 mΩ Max. Switch: 300 mΩ Max
Temperature Rise	Apply test current of loaded rating and measure the temperature rise of contact when rated current is passed. In accordance with EIA-364-70 Method 1.	30°C Max.
Solderability	Dip solders tails into molten solder up to a depth of 0.5mm, held at a temperature of 250±5°C for 3±0.5 second.	95% of immersed area must show no voids of pin holes.
Resistance to Reflow Soldering Heat.	Mount connector, place in reflow oven and expose to the temperature profile with peak temperature of 250°C for 15seconds. See Fig. 1.	No evidence of physical damage or abnormalities adversely affecting performance

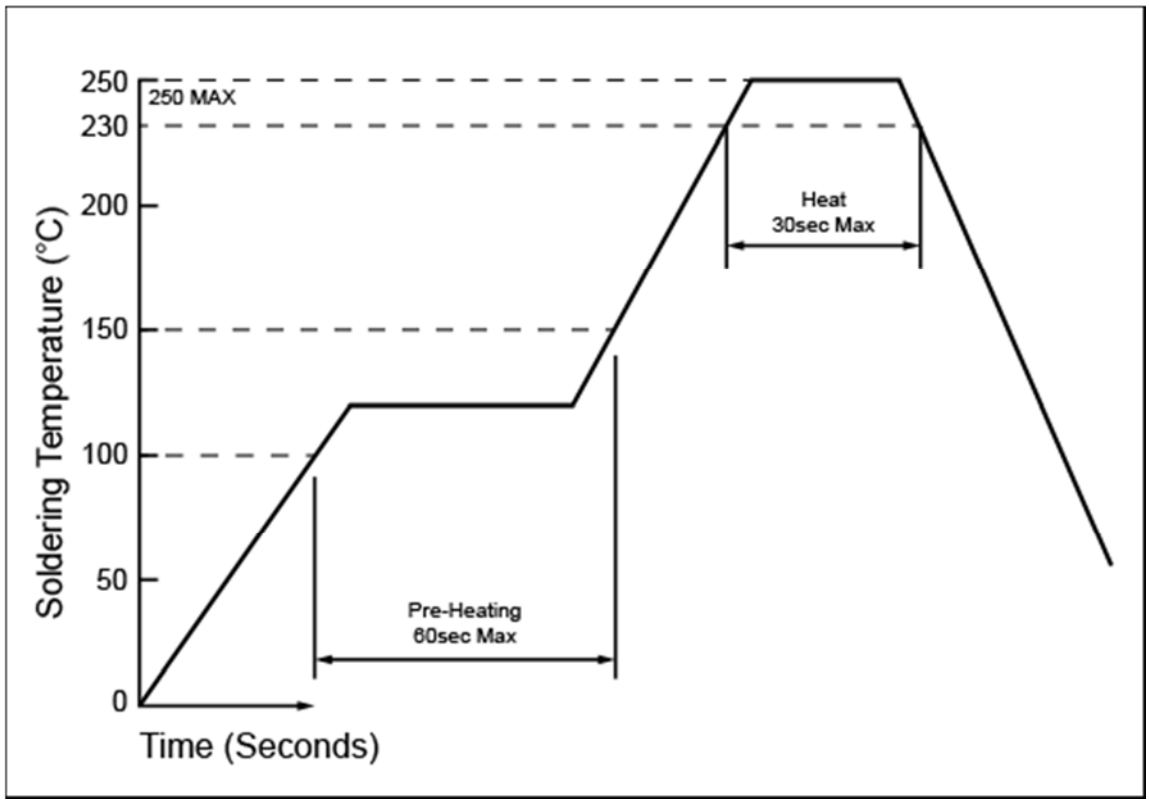


Fig. 1. Recommended Reflow Temp. Profile

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Product Description	Micro SIM Card Connector, Push-Push, 6 or 8 Pin, SMT, 1.5mm Profile, With Card Detection Switch						Page	6
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7.0 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test Item	Group									
	A	B	C	D	E	F	G	H	I	J
Examination of Product	1,5	1,5	1,5	1,5	1,9	1,6	1,3	1,3	1,9	1,3
Contact Resistance	2,4	2,4	2,4	2,4	2,6	2,5			2,6	
Insulation Resistance					3,7				3,7	
Dielectric Withstanding					4,8				4,8	
Durability					5					
Vibration(random)						3				
Mechanical Shock						4				
Thermal Shock	3									
Humidity									5	
Salt mist		3								
Temperature Life (High)				3						
Temperature Life (Low)			3							
Temperature Rise								2		
Solderability							2			
Resistance to Reflow Soldering Heat.										2
Sample QTY.	5	5	5	5	5	5	5	5	5	5

PRODUCT SPECIFICATION

Part Number	SIM7100		**Rev**	C		**Date**	17/12/19
Product Description	Micro SIM Card Connector, Push-Push, 6 or 8 Pin, SMT, 1.5mm Profile, With Card Detection Switch					**Page**	7
Doc Number	SIM7100	**Prepared**	**CC**	**Checked**	**VJ**	**Approved**	**PH**

Revision details

Revision	Information	Page	Release Date
A	Specification Released	-	05/09/2014
B	Update the 3D image on the cover page	1	18/04/2018
C	Update the 3D image on the cover page	1	17/12/2019